

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT														
NATURE OF CONVEYANCE:	ASSIGNMENT														
CONVEYING PARTY DATA															
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Daniel J. Coady</td><td>11/05/2010</td></tr><tr><td>Urs T. Duerig</td><td>09/27/2010</td></tr><tr><td>Jane E. Frommer</td><td>11/10/2010</td></tr><tr><td>Kazuki Fukushima</td><td>11/04/2010</td></tr><tr><td>James L. Hedrick</td><td>11/10/2010</td></tr><tr><td>Armin W. Knoll</td><td>10/18/2010</td></tr></tbody></table>		Name	Execution Date	Daniel J. Coady	11/05/2010	Urs T. Duerig	09/27/2010	Jane E. Frommer	11/10/2010	Kazuki Fukushima	11/04/2010	James L. Hedrick	11/10/2010	Armin W. Knoll	10/18/2010
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RECEIVING PARTY DATA															
<table border="1"><tr><td>Name:</td><td>International Business Machines Corporation</td></tr><tr><td>Street Address:</td><td>20 Church Street</td></tr><tr><td>Internal Address:</td><td>22nd Floor</td></tr><tr><td>City:</td><td>Hartford</td></tr><tr><td>State/Country:</td><td>CONNECTICUT</td></tr><tr><td>Postal Code:</td><td>06103</td></tr></table>		Name:	International Business Machines Corporation	Street Address:	20 Church Street	Internal Address:	22nd Floor	City:	Hartford	State/Country:	CONNECTICUT	Postal Code:	06103		
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PROPERTY NUMBERS Total: 1															
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>12894412</td></tr></tbody></table>		Property Type	Number	Application Number:	12894412										
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Application Number:	12894412														
CORRESPONDENCE DATA															
Fax Number: (860)286-0115 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>															
Phone: 860-286-2929															
Email: jmasotti@cantorcolburn.com															
Correspondent Name: CANTOR COLBURN LLP-IBM YORKTOWN															
Address Line 1: 20 Church Street															
Address Line 2: 22nd Floor															
Address Line 4: Hartford, CONNECTICUT 06103															
ATTORNEY DOCKET NUMBER:	CH920100037US1														

PATENT

501347637

REEL: 025348 FRAME: 0529

CH \$40.00 12894412

NAME OF SUBMITTER:

Sean F. Sullivan

Total Attachments: 12

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ASSIGNMENT

Whereas, the undersigned Inventor(s) has/have made certain inventions, improvements, and discoveries (herein referred to as the "Invention") in:

Title of the Invention: Patterning Nano-Scale Patterns on a Film Comprising Unzipping Copolymers
and further identified by the IBM Docket Number provided above in the header of this Assignment, for which an application for a United States Patent was executed concurrently herewith or was filed having:

Serial Number: 12/894,412 (insert series code and serial number here if/when available)

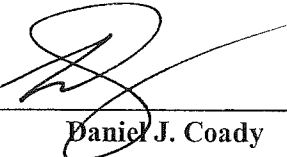
Whereas, International Business Machines Corporation, a corporation of New York having a place of business at Armonk, New York (herein referred to as "IBM"), desires to acquire, and each undersigned Inventor desires to grant to IBM, the entire worldwide right, title, and interest in and to the Invention and in and to any and all patent applications and patents directed thereto;

Now, therefore, for good and valuable consideration, the receipt and sufficiency thereof being hereby acknowledged, each undersigned Inventor ("ASSIGNOR") hereby sells, assigns, and otherwise transfers to IBM (the "ASSIGNEE"), its successors, legal representatives, and assigns, the entire worldwide right, title, and interest in and to the Invention, the above-identified United States patent application, and any and all other patent applications and patents for the Invention which may be applied for or granted therefor in the United States and in all foreign countries and jurisdictions, including all divisions, continuations, reissues, reexaminations, renewals, extensions, counterparts, substitutes, and extensions thereof, and all rights of priority resulting from the filing of such applications and granting of such patents. In addition, each undersigned Inventor hereby authorizes and requests the Director of the United States Patent and Trademark Office to issue any United States Patent, and foreign patent authorities to issue any foreign patent, granted for the Invention, to IBM, its successors, legal representatives, and assigns, the entire worldwide right, title, and interest in and to the same to be held and enjoyed by IBM, its successors, legal representatives, and assigns to the full end of the terms for which any and all such patents may be granted, as fully and entirely as would have been held and enjoyed by the undersigned had this Assignment not been made; and each undersigned Inventor agrees to execute any and all documents and instruments and perform all lawful acts reasonably related to recording this Assignment or perfecting title to the Invention and all related patents and applications, in IBM, its successors, legal representatives, and assigns, whenever requested by IBM, its successors, legal representatives, or assigns.

Each undersigned Inventor acknowledges their prior and ongoing obligations to sell, assign, and transfer the rights under this Assignment to IBM and is unaware of any reason why they may not have the full and unencumbered right to sell, assign, and transfer the rights hereby sold, assigned, and transferred, and has not executed, and will not execute, any document or instrument in conflict herewith. Each undersigned Inventor also hereby grants IBM, its successors, legal representatives, and assigns, the right to insert in this Assignment any further identification (including, but not limited to, patent application Serial Number) which may be necessary or desirable for recordation of this Assignment. This Assignment is governed by the substantive laws of the State of New York, and any disputes will be resolved in a New York state court or federal court sited in New York.

[Inventor Signature Page(s) Follows]

Executed by Inventor 1

Signature:  Date: 11/5/10
Daniel J. Coady

Executed by Inventor 2

Signature: _____ Date: _____
Urs T. Duerig

Executed by Inventor 3

Signature: _____ Date: _____
Jane E. Frommer

Executed by Inventor 4

Signature:  Date: 11-04-2010
Kazuki Fukushima

Executed by Inventor 5

Signature: _____ Date: _____
James L. Hedrick

Executed by Inventor 6

Signature: _____ Date: _____
 Armin W. Knoll

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1Executed by Inventor 1

Signature: _____ Date: _____

Daniel J. Coady

1Executed by Inventor 2

Signature: _____ Date: Sept 27 2010


Urs T. Duerig

1Executed by Inventor 3

Signature: _____ Date: _____

Jane E. Frommer

1Executed by Inventor 4

Signature: _____ Date: _____

Kazuki Fukushima

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Signature: _____ Date: _____

James L. Hedrick

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Kazuki Fukushima

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Signature: _____ Date: _____
James L. Hedrick

1 Executed by Inventor 6

Signature: Armin W. Knoll Date: Oct 18, 2010
Armin W. Knoll